

IN THE CLAIMS

Please amend the claims as follows.

1.-35. (Canceled)

36. (Previously Presented) A device comprising:

a dispenser configured to release a chemical toward an edge bead of a substrate; and
a splash controller concentrically positioned at least partially around said dispenser and
physically unattached from the edge bead, the splash controller being configured to draw
the chemical from at least one surface of the substrate and toward said splash controller,
wherein said splash controller is configured to generate a gas pressure around the edge
bead that is lower than an ambient gas pressure, and wherein said splash controller is
configured to physically intercept the chemical.

37. (Previously Presented) The device in claim 36, wherein the splash controller is around the
edge bead.

38. (Previously Presented) The device of claim 36, wherein the splash controller completely
surrounds said dispenser.

39. (Previously Presented) The device of claim 36, wherein the dispenser has a diameter smaller
than a diameter of the splash controller.

40. (Previously Presented) The device of claim 36, wherein said dispenser is configured to
release a chemical on a first side of a wafer and a second side of the wafer toward an edge bead,
wherein the splash controller completely surrounds said dispenser.

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